HEF4104B

Quad low-to-high voltage translator with 3-state outputs Rev. 07 — 16 December 2009 Product data

Product data sheet

General description 1.

The HEF4104B is a quad low voltage-to-high voltage translator with 3-state outputs. It provides the capability of interfacing low voltage circuits to high voltage circuits. For example low voltage Local Oxidation Complementary MOS (LOCMOS) and Transistor Transistor Logic (TTL) to high voltage LOCMOS. It has four data inputs (A0 to A3), an active HIGH output enable input (OE), four data outputs (B0 to B3) and their complements $(\overline{B}0 \text{ to } \overline{B}3).$

With OE = HIGH, the outputs B0 to B3 and $\overline{B}0$ to $\overline{B}3$ are in the low impedance ON-state, either HIGH or LOW as determined by the inputs A0 to A3. With OE = LOW, the outputs B0 to B3 and B0 to B3 are in the high-impedance OFF-state.

It uses a common negative supply (V_{SS}) and separate positive supplies for the inputs $(V_{DD(A)})$ and the outputs $(V_{DD(B)})$. $V_{DD(A)}$ must always be less than or equal to $V_{DD(B)}$, even during power turn-on and turn-off. For the permissible operating range of V_{DD(A)} and V_{DD(B)} see Figure 4.

Each input protection circuit is terminated between V_{DD(B)} and V_{SS}. This allows the input signals to be driven from any potential between V_{DD(B)} and V_{SS}, without regard to current limiting. When driving from potentials greater than $V_{DD(B)}$ or less than V_{SS} , the current at each input must be limited to 10 mA.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input. It is also suitable for use over the full industrial (-40 °C to +85 °C) temperature range.

Features

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Inputs and outputs are protected against electrostatic effects
- Operates across the full industrial temperature range from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

Applications

Industrial





Quad low-to-high voltage translator with 3-state outputs

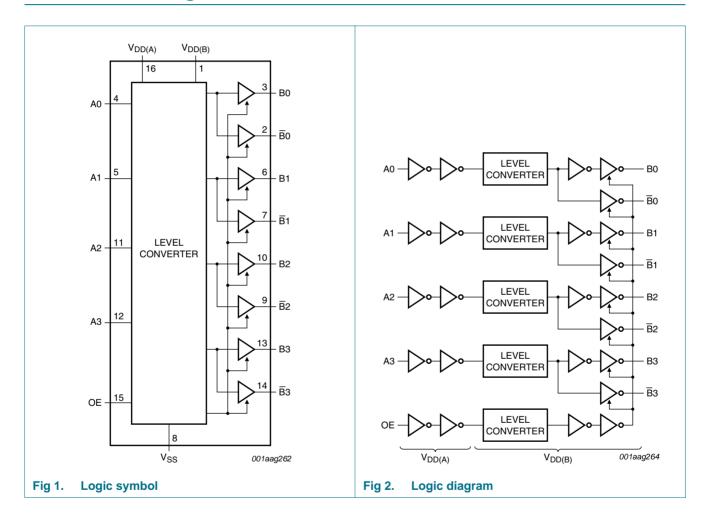
Ordering information 4.

Table 1. **Ordering information**

All types operate from -40 °C to +85 °C.

Type number Package						
	Name	Description	Version			
HEF4104BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4			
HEF4104BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1			

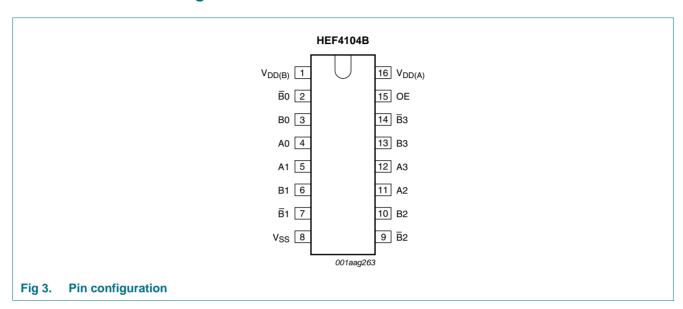
5. **Functional diagram**



Quad low-to-high voltage translator with 3-state outputs

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description	
$V_{DD(B)}$	1	supply voltage port B	
B0 to B3	2, 7, 9, 14	complementary data output	
B0 to B3	3, 6, 10, 13	data output	
A0 to A3	4, 5, 11, 12	data input	
V _{SS}	8	common negative supply voltage (0 V)	
OE	15	output enable input	
$V_{DD(A)}$	16	supply voltage port A	

7. Functional description

Table 3. Function table[1]

Control	Output	
OE	Bn	Bn
Н	An	Ān
L	Z	Z

^[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

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8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{SS} = 0 \text{ V (ground)}$.

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD(A)}$	supply voltage A	port A; $V_{DD(A)} \le V_{DD(B)}$	-0.5	+18	V
$V_{DD(B)}$	supply voltage B	port B; $V_{DD(B)} \ge V_{DD(A)}$	-0.5	+18	V
I _{IK}	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{DD(A)} + 0.5 \text{ V}$	-	±10	mA
V_{I}	input voltage		-0.5	$V_{DD(A)} + 0.5$	V
I_{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{DD(B)} + 0.5 \text{ V}$	-	±10	mA
$I_{I/O}$	input/output current		-	±10	mA
I_{DD}	supply current		<u>[1]</u> -	50	mA
T_{stg}	storage temperature		-65	+150	°C
T_{amb}	ambient temperature		-40	+85	°C
P_{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$			
		DIP16	[2] -	750	mW
		SO16	<u>[3]</u> _	500	mW
Р	power dissipation	per output	-	100	mW

^[1] I_{DD} is the combined current of $I_{DD(A)}$ and $I_{DD(B)}$.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DD(A)}$	supply voltage A		3	-	$\leq V_{DD(B)}$	V
$V_{DD(B)}$	supply voltage B		$\geq V_{DD(A)}$	-	15	V
VI	input voltage		0	-	$V_{DD(A)}$	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD(A)} = 5 V$	-	-	3.75	μs/V
		$V_{DD(A)} = 10 \text{ V}$	-	-	0.5	μs/V
		V _{DD(A)} = 15 V	-	-	0.08	μs/V

^[2] For DIP16 packages: above T_{amb} = 70 °C, P_{tot} derates linearly at 12 mW/K.

^[3] For SO16 packages: above T_{amb} = 70 °C, P_{tot} derates linearly at 8 mW/K.

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10. Static characteristics

Table 6. **Static characteristics**

 $V_{DD(A)} = V_{DD(B)}$; $V_{SS} = 0$ V; $V_I = V_{SS}$ or $V_{DD(A)}$; unless otherwise specified.

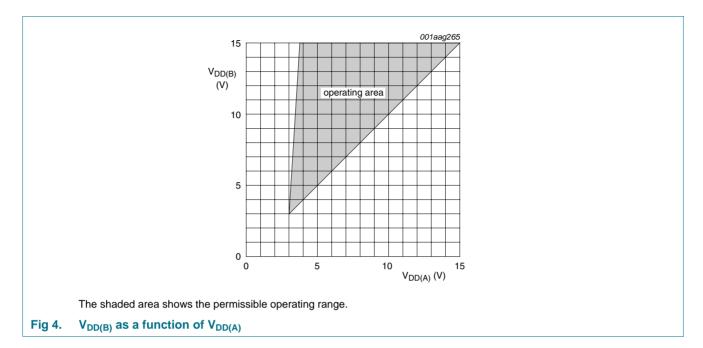
Symbol	Parameter	Conditions	V _{DD} [1]	T _{amb} =	-40 °C	T _{amb} =	+25 °C	T _{amb} =	+85 °C	Unit
				Min	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
V _{IL}	LOW-level	$ I_{O} < 1 \mu A$	5 V	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level	$ I_{O} < 1 \mu A$	5 V	4.95	-	4.95	-	4.95	-	V
	output voltage		10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V _{OL} LOW-level	LOW-level	$ I_{O} < 1 \mu A$	5 V	-	0.05	-	0.05	-	0.05	V
	output voltage		10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level	V _O = 2.5 V	5 V	-1.7	-	-1.4	-	-1.1	-	mΑ
	output current $V_O = 4$.	V _O = 4.6 V	5 V	-0.52	-	-0.44	-	-0.36	-	mΑ
		V _O = 9.5 V	10 V	-1.3	-	-1.1	-	-0.9	-	mΑ
		V _O = 13.5 V	15 V	-3.6	-	-3.0	-	-2.4	-	mΑ
l _{OL}	LOW-level	$V_0 = 0.4 \text{ V}$	5 V	0.52	-	0.44	-	0.36	-	mΑ
	output current	V _O = 0.5 V	10 V	1.3	-	1.1	-	0.9	-	mΑ
		V _O = 1.5 V	15 V	3.6	-	3.0	-	2.4	-	mΑ
I _I	input leakage current		15 V	-	±0.3	-	±0.3	-	±1.0	μΑ
I _{DD}	supply current	all valid input	5 V	[2] _	20	-	20	-	150	μΑ
		combinations;	10 V	-	40	-	40	-	300	μΑ
		$I_O = 0 A$	15 V	-	80	-	80	-	600	μΑ
l _{OZ}	OFF-state output current	HIGH level; $V_O = V_{DD(B)}$	15 V	-	1.6	-	1.6	-	12.0	μΑ
		LOW level; V _O = V _{SS}	15 V	-	-1.6	-	-1.6	-	-12.0	μΑ
Cı	input capacitance	digital inputs	-	-	-	-	7.5	-	-	pF

^[1] V_{DD} is the same as $V_{DD(A)}$ and $V_{DD(B)}$.

^[2] I_{DD} is the combined current of $I_{DD(A)}$ and $I_{DD(B)}$.

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11. Dynamic characteristics

Table 7. Dynamic characteristics

 $T_{amb} = 25$ °C; for test circuit see <u>Figure 7</u>; unless otherwise specified.

Symbol	Parameter	Conditions	Extrapolation formula[1]	Min	Тур	Max	Unit
t_{PHL}	HIGH to LOW	An to Bn, Bn; see Figure 5					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 \text{ V}$	143 ns + $(0.55 \text{ ns/pF})C_L$	-	170	340	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$	69 ns + $(0.23 \text{ ns/pF})C_L$	-	80	160	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$	57 ns + $(0.16 \text{ ns/pF})C_L$	-	65	135	ns
t _{PLH}	LOW to HIGH	An to Bn, Bn; see Figure 5					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 \text{ V}$	143 ns + $(0.55 \text{ ns/pF})C_L$	-	170	340	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$	69 ns + $(0.23 \text{ ns/pF})C_L$	-	80	160	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$	62 ns + $(0.16 \text{ ns/pF})C_L$	-	70	140	ns
t _{THL}	HIGH to LOW output transition time	Bn or Bn; see Figure 6					
		$V_{DD(A)} = V_{DD(B)} = 5 \text{ V}$	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$	9 ns + $(0.42 \text{ ns/pF})C_L$	-	30	60	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$	6 ns + $(0.28 \text{ ns/pF})C_L$	-	20	40	ns
t _{TLH}	LOW to HIGH output	Bn or Bn; see Figure 6					
	transition time	$V_{DD(A)} = V_{DD(B)} = 5 \text{ V}$	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$	6 ns + $(0.28 \text{ ns/pF})C_L$	-	20	40	ns
t _{PHZ}	HIGH to OFF-state	OE to Bn, Bn; see Figure 6					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 \text{ V}$		-	70	135	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$		-	55	110	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$		-	60	120	ns



Quad low-to-high voltage translator with 3-state outputs

Table 7. **Dynamic characteristics** ...continued

T_{amb} = 25 °C; for test circuit see Figure 7; unless otherwise specified.

Symbol	Parameter	Conditions	Extrapolation formula[1]	Min	Тур	Max	Unit
t_{PLZ}	LOW to OFF-state	OE to Bn, Bn; see Figure 6					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 \text{ V}$		-	70	135	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$		-	55	105	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$		-	55	110	ns
t _{PZH} OFF-state to HIGH	OE to Bn, Bn; see Figure 6						
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 \text{ V}$		-	195	395	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$		-	95	195	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$		-	80	165	ns
t_{PZL}	OFF-state to LOW	OE to Bn, Bn; see Figure 6					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 \text{ V}$		-	195	395	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$		-	95	190	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$		-	80	160	ns

^[1] Typical value of the propagation delay and output transition time can be calculated with the extrapolation formula (C_L in pF).

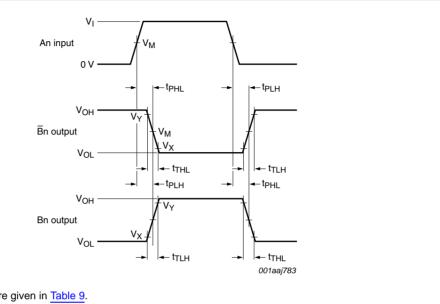
Dynamic power dissipation

 $V_{DD(A)} = V_{DD(B)}$; $V_{SS} = 0$ V; $t_f = t_f \le 20$ ns; $T_{amb} = 25$ °C.

Symbol	Parameter	۷ _{DD} [1]	Typical formula (μW)	where
P_{D}	dynamic power	5 V	$P_D = 3000 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}{}^2$	f_i = input frequency in MHz;
	dissipation	10 V	$P_D = 12200 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f _o = output frequency in MHz;
		15 V	$P_D = 31000 \times f_i + \Sigma (f_0 \times C_L) \times V_{DD}^2$	C _L = output load capacitance in pF;
				$\Sigma(f_0 \times C_L)$ = sum of the outputs;
				V_{DD} = supply voltage in V.

^[1] V_{DD} is the same as $V_{DD(A)}$ and $V_{DD(B)}$.

12. Waveforms



Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 5. Data input (An) to data output (Bn, Bn) propagation delays and output transition times

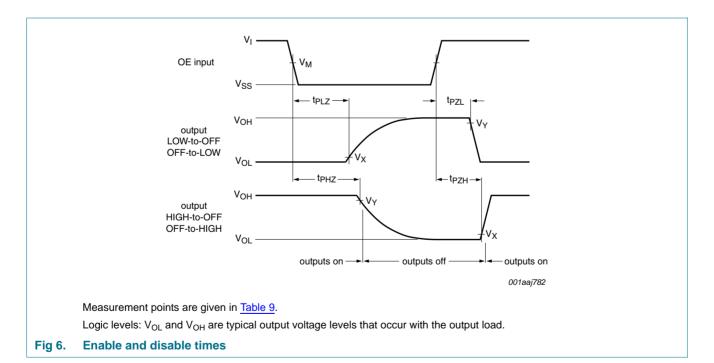


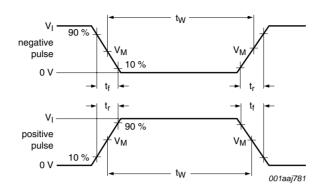
Table 9. Measurement points

Input		Output			
V _I	V _M	V _M	V _X	V _Y	
V_{SS} or $V_{DD(A)}$	0.5V _{DD(A)}	0.5V _{DD(B)}	0.1V _{DD(B)}	0.9V _{DD(B)}	

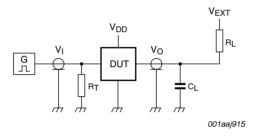
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Quad low-to-high voltage translator with 3-state outputs



a. Input waveforms



b. Test circuit

Test data given in Table 10.

Definitions for test circuit:

DUT = Device Under Test.

 C_L = load capacitance including jig and probe capacitance.

R_L = load resistance.

 R_T = termination resistance should be equal to the output impedance Z_0 of the pulse generator.

Fig 7. Test circuit for measuring switching times

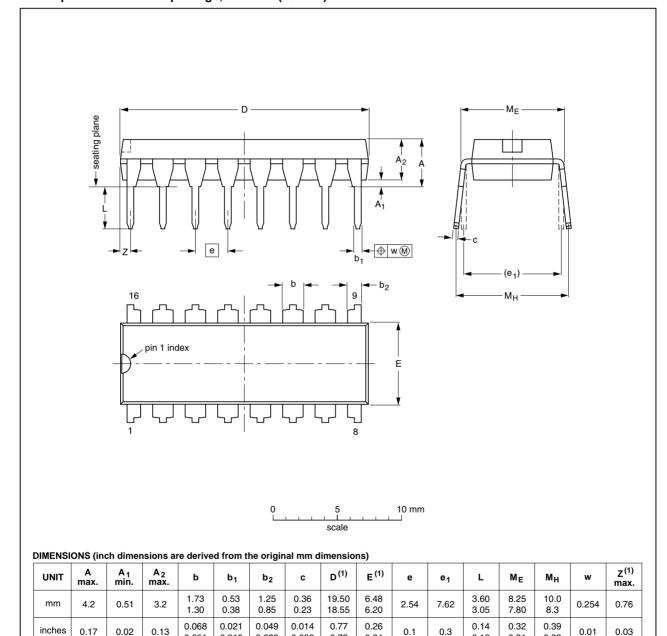
Table 10. Test data

Supplies	Input	Load		V _{EXT}		
$V_{DD(A)} = V_{DD(B)}$	t _r , t _f	R _L	R _L C _L		t _{PZL} , t _{PLZ}	t _{PZH} , t _{PHZ}
5 V to 15 V	≤ 20 ns	1 kΩ	50 pF	open	$V_{DD(B)}$	V _{SS}

13. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



Note

0.015

0.033

0.009

0.051

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT38-4					95-01-14 03-02-13

Fig 8. Package outline SOT38-4 (DIP16)

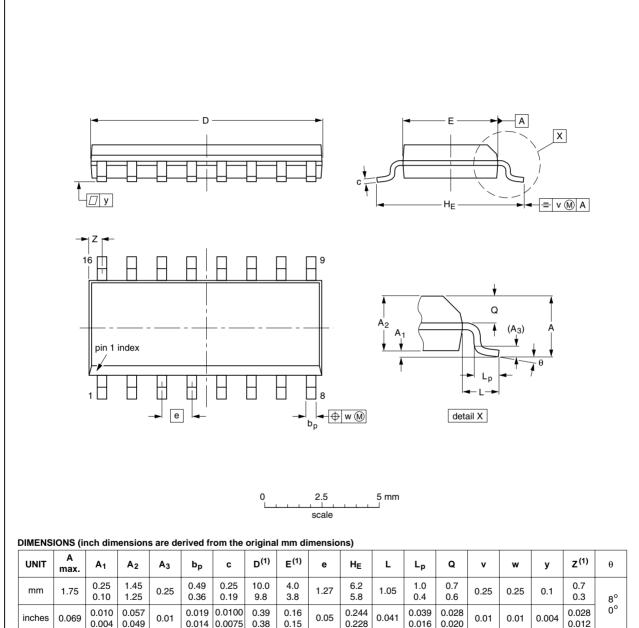
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^{1.} Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

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UNII max.	A ₁	A ₂	А3	рp		עייע	E'''	е	HE		−p	•		W	y	۷٠٠/	θ
mm 1.75	0.25	1.45	0.25	0.49	0.25	10.0	4.0	12/	6.2	1.05 1.0 0.4	_	0.7	0.25 0.25	0.1	0.7		
1.70	0.10	1.25		0.36	0.19	9.8	3.8	,	5.8		0.4	0.6		0.20	0.1	0.3	8° 0°
inches 0.069		0.057			0.0100	0.39	0.16	0.05	0.244	0.041	0.039	0.028	0.01	0.01	0.004	0.028	
0.005	0.004	0.049	0.01	0.014	0.0075	0.38	0.15	0.00	0.228	0.011	0.016	0.020	0.01	0.01	0.004	0.012	

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE	
SOT109-1	076E07	MS-012				99-12-27 03-02-19	

Package outline SOT109-1 (SO16) Fig 9.

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Quad low-to-high voltage translator with 3-state outputs

14. Revision history

Table 11. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4104B_7	20091216	Product data sheet	-	HEF4104B_6
Modifications:	 Section 12 " 	Waveforms" Figure 7 "Test of	circuit for measuring sw	vitching times" updated.
HEF4104B_6	20091102	Product data sheet	-	HEF4104B_5
HEF4104B_5	20090728	Product data sheet	-	HEF4104B_4
HEF4104B_4	20090305	Product data sheet	-	HEF4104B_CNV_3
HEF4104B_CNV_3	19950101	Product specification	-	HEF4104B_CNV_2
HEF4104B_CNV_2	19950101	Product specification	-	-



Quad low-to-high voltage translator with 3-state outputs

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Quad low-to-high voltage translator with 3-state outputs

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